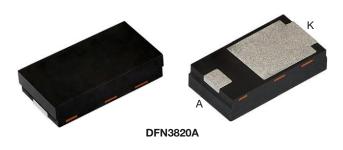
V3NM63



Vishay General Semiconductor

Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier



Anode O Cathode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS						
I _{F(AV)} 3 A						
V _{RRM}	60 V					
I _{FSM}	80 A					
V _F at I _F = 1.5 A (T _J = 125 °C)	0.42 V					
T _J max.	175 °C					
Package	DFN3820A					
Circuit configuration	Single					

FEATURES

- Low profile package typical height of 0.88 mm
 Available
- Leadless DFN package with side-wettable flanks suitable for customer AOI (Automatic Optical Inspection)
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 Automotive ordering code; base P/NHM3
- Compatible to SMP (DO-220AA) package case outline
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: DFN3820A

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test **Polarity:** color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	V3NM63	UNIT				
Device marking code		3MF					
Maximum repetitive peak reverse voltage	V _{RRM}	60	V				
Maximum average forward rectified current (fig. 1)	I _{F(AV)} ⁽¹⁾	3	А				
Maximum average forward rectined current (ng. 1)	I _{F(AV)} ⁽²⁾	2.2	А				
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	80	A				
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C				
Storage temperature range	T _{STG}	-55 to +175	°C				

Notes

⁽¹⁾ Mounted on 10 mm x 10 mm copper pad area PCB

(2) Free air, mounted on FR4 PCB, 2 oz., standard footprint

⁽³⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

 Revision 06-Nov-2024
 1
 Document Number: 98438

 For technical questions within your region:
 DidesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com

 THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE.
 THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT

 ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



RoHS

COMPLIANT HALOGEN

FREE





www.vishay.com

Vishay General Semiconductor

ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)								
PARAMETER	TEST CO	ONDITIONS	SYMBOL	TYP.	MAX.	UNIT		
Instantaneous forward voltage	I _F = 1.5 A	T _J = 25 °C		0.51	-			
	$I_{F} = 3.0 \text{ A}$	$I_{\rm F} = 3.0 \rm{A}$		0.58	0.63	v		
	I _F = 1.5 A	T _J = 125 °C	V _F ⁽¹⁾	0.42	-	v		
	I _F = 3.0 A	1j=125 C		0.50	0.56			
Reverse current	V _B = 60 V	T _J = 25 °C T _{.1} = 125 °C	I _R ⁽²⁾	-	0.01	mA		
	$v_{\rm R} = 00 v$	T _J = 125 °C		0.4	1.5	IIIA		
Typical junction capacitance	4.0 V, 1 MH	4.0 V, 1 MHz		560	-	pF		

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: pulse width \leq 5 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Thermal resistance	R _{0JA} (1)(2)	135	169	°C/W			
	R _{θJM} ⁽³⁾	5	6.3	0/10			

Notes

⁽¹⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint

⁽³⁾ Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION TABLE

Device code	v	3	Ν	м	6	3	н	М3	
	1	2	3	4	5	6	7	8	
	1 -	Visl	nay TME	3S prod	uct				
	2 -	Cur	rent rati	ng (3 =	3 A)				
	3 -	- Package type (N = DFN3820A)							
	4 -	- Process type option (M = Iow I _R)							
	5 -	Vol	Voltage rating (6 = 60 V)						
	6 -	ТМ	TMBS generation option (3 = Gen3)						
	7 -	Qua	Quality grade (H = AEC-Q101 qualified, otherwise = industry grade)						
	8 -				ient cate nd termi			-	ee,

ORDERING INFORMATION (Example)								
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE				
V3NM63-M3/H	0.023	Н	3500	7" diameter plastic tape and reel				
V3NM63-M3/I	0.023	l	14 000	13" diameter plastic tape and reel				
V3NM63HM3/H ⁽¹⁾	0.023	н	3500	7" diameter plastic tape and reel				
V3NM63HM3/I ⁽¹⁾	0.023	I	14 000	13" diameter plastic tape and reel				

Note

⁽¹⁾ AEC-Q101 qualified

 Revision 06-Nov-2024
 2
 Document Number: 98438

 For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
 DiodesEurope@vishay.com

 THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Vishay General Semiconductor

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

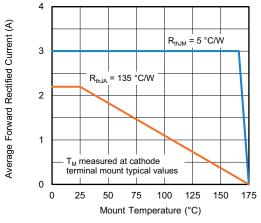


Fig. 1 - Maximum Forward Current Derating Curve

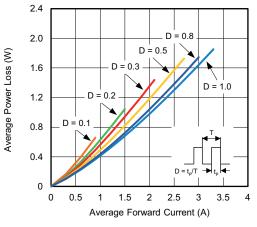


Fig. 2 - Forward Power Loss Characteristics

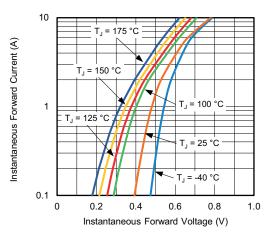


Fig. 3 - Typical Instantaneous Forward Characteristics

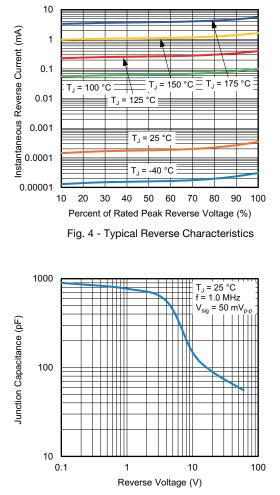


Fig. 5 - Typical Junction Capacitance

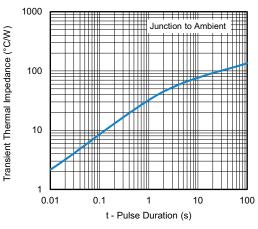


Fig. 6 - Typical Transient Thermal Impedance

Revision 06-Nov-2024

3

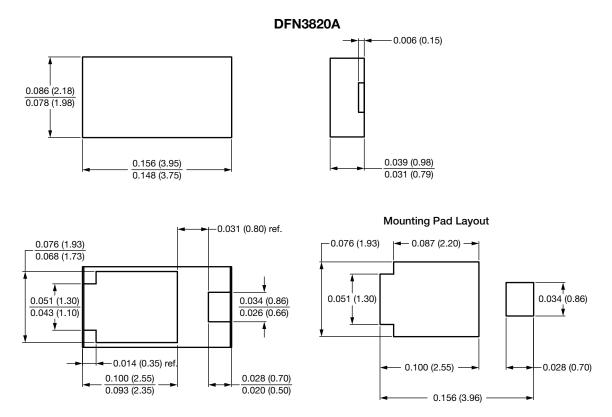
Document Number: 98438

For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Vishay General Semiconductor

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2025 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED

Revision: 01-Jan-2025

1